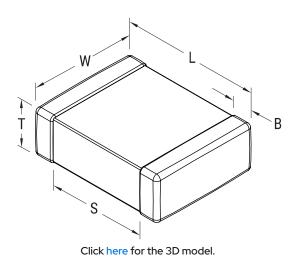




ESD SMD Comm COG, Ceramic, 0.1 uF, 5%, 25 VDC, COG, SMD, MLCC, Temperature Stable, Electro Static Discharge, Class I, 1.5 mm, 1206 / 3216



General Information	
Series	ESD SMD Comm COG
Style	SMD Chip
Description	SMD, MLCC, Temperature Stable, Electro Static Discharge, Class I
Features	Temperature Stable, Low ESR, Class I
RoHS	Yes
Termination	Flexible Termination
Marking	No
AEC-Q200	No
Typical Component Weight	36 mg
Shelf Life	78 Weeks
MSL	1

Dimensions	
L	3.3mm +/-0.4mm
W	1.6mm +/-0.35mm
Т	1.6mm +/-0.20mm
S	1.5mm MIN
В	0.6mm +/-0.25mm
Case Code (EIA / mm)	1206 / 3216

S	1.5mm MIN
В	0.6mm +/-0.25mm
Case Code (EIA / mm)	1206 / 3216
Packaging Specifications	
Packaging	Bulk, Bag

Packaging Quantity

Specifications	
Capacitance	0.1 uF
Measurement Condition	1 kHz 1.0Vrms
Tolerance	5%
Voltage DC	25 VDC
ESD Level per AEC-Q200	25,000 V ESD Level
Dielectric Withstanding Voltage	62.5 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1kHz 1.0Vrms
Dissipation Factor	0.1% 1 kHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	10 GOhms

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